

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Daniel Yap, et al.) Re: Preliminary Amendment
Serial No.: Not yet assigned)) Group: unknown
Filed: concurrently herewith)) Examiner: unknown
For: "PRECISION ELECTROPLATED SOLDER)
BUMPS AND METHOD FOR)) Our Ref: B-3752DIV 619413-2
MANUFACTURING THEREOF")) Date: January 15, 2002

Commissioner of Patents and Trademarks
BOX NEW PATENT APPLICATION
Washington, D.C. 20231

Sir:

The above-identified application is a divisional of pending prior U.S. Patent Application Serial No. 09/522,803 filed on March 9, 2001. Prior to examining this divisional application, it is respectfully requested that the following amendments be made:

IN THE CLAIMS

Please cancel Claims 1 - 20, as filed. Therefore, examination of Claims 21 - 31, as filed, is requested.

REMARKS

Amendment of the subject application is respectfully requested.

Respectfully submitted,



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